



Short communication

## Modification of nanocrystalline porous films by poly(ethyleneglycol) for quasi-solid dye-sensitized solar cells

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## ABSTRACT

A convenient way is experimented to reduce the amount of dye in quasi-solid DSSCs but raise open-circuit photovoltage and photocurrent density. AFM stereoscopic morphology and calculated roughness of root mean square indicates looser porous configuration is formed in the modified TiO<sub>2</sub> film which is beneficial for the penetration of quasi-solid electrolyte. Decreased content of sensitized dye is confirmed by UV–vis absorption spectra. Electrochemical impedance spectroscopy is employed to characterize the transport and recombination of electrons and also to assess the penetration of quasi-solid electrolyte in the porous matrix of DSSCs. Analysis of charge-transfer resistance and dc resistance of impedance of diffusion of tri-iodide reveals enhanced mobility of tri-iodide in DSSCs. Photovoltaic parameters of quasi-solid DSSCs show an increased open-circuit photovoltage due to the enlarged photoelectrode film porosity and the shift of redox level. Better penetration of quasi-solid electrolyte has a predominant advantage over the negative effect caused by lose of photocurrent, to some extent, as a result of decreased adsorbed dye. The best result of this beneficial outcome occurs when the PEG loading is 20%, giving an overall cell efficiency of 5.1%.

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### 1. Introduction

Since O'Regan and Gratzel [1] reported the dye-sensitized nanocrystalline TiO<sub>2</sub> solar cell with an efficiency up to 7% in 1991, many academic and commercial researchers have shown much interest in dye-sensitized solar cells (DSSCs) for its low cost of fabrication and acceptable energy conversion efficiency. Some reporters have even risen the device conversion efficiency over 10% under standard AM 1.5 sunlight [2–7]. However, most high-conversion-efficiency DSSCs are based on liquid electrolyte which is not suitable for industrialization because the problems of leakage and volatility of the solvent. Therefore, quasi-solid or solid electrolytes, such as polymer electrolyte [8–10], organic electrolyte [11,12] have been employed in DSSCs by many researchers. In these electrolytes, mobility of ions is however lower than that of liquid electrolytes. Hence the efficient penetration of non-liquid electrolyte in nanostructured thin films, or photoelectrode has very important influence on the whole performance of the device. We proposed a method to improve the DSSCs overall conversion efficiency and reduce the amount of dye by modifying nanocrystalline porous TiO<sub>2</sub> thin films with PEG. Micrographs of morphologies of

different photoelectrodes explored with atomic force microscopy (AFM) enabling height imaging in tapping mode to compare electrolyte penetration in these photoelectrodes. UV–vis absorption spectra were analyzed to compare the amount of dye adsorbed on the inner surface of these photoelectrodes. Photovoltaic parameters, short-circuit current density  $J_{sc}$  and open-circuit voltage  $V_{oc}$ , were also analyzed to compare the effects on overall conversion efficiency of DSSCs by adjusting the amount of PEG in TiO<sub>2</sub> paste. Electrochemical impedance spectroscopy (EIS) was applied to characterize the transport and recombination of electrons, and to assess the penetration of quasi-solid electrolyte in DSSCs. Charge-transfer resistance and dc resistance of impedance of diffusion of tri-iodide are discussed to evaluate the mobility of tri-iodide in the device.

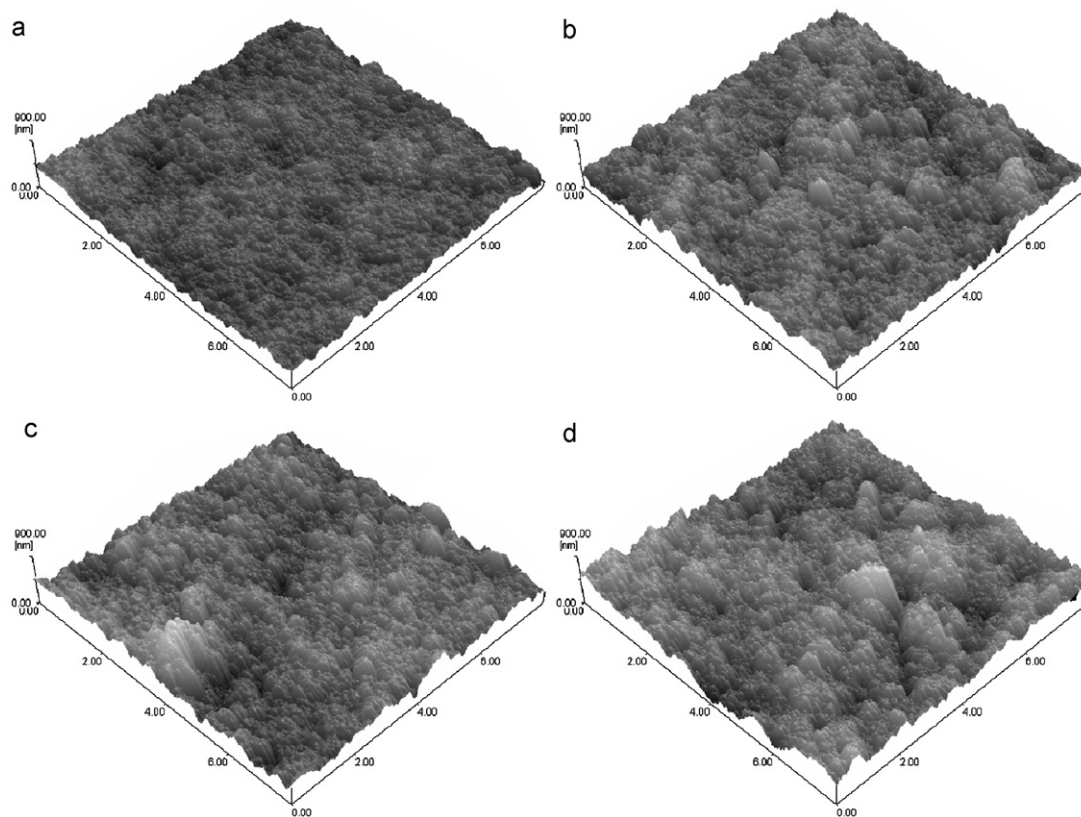
### 2. Experimental details

#### 2.1. Materials

TiO<sub>2</sub> nanoparticles (P25, 20–30 nm, BET 48 m<sup>2</sup> g<sup>-1</sup> Degussa AG, Germany)

SiO<sub>2</sub> nanoparticles (aerosil 200, 12–15 nm, Degussa AG, Germany);  
LiI (Acros); I<sub>2</sub> (Beijing Yili chemicals, China);  
N719 (Solaronix, Switzerland);

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**Fig. 1.** Stereoscopic morphologies of different photoelectrodes: (a) 10% PEG added, (b) 20% PEG added, (c) 30% PEG added, (d) 40% PEG added in the paste scanned with AFM in tapping mode.

Triton-X100, ethanol, acetylacetone, Propylene Carbonate (PC) were purchased from Sinopharm Chemical Reagent Corporation (China);

Fluorine-doped SnO<sub>2</sub> conductive glass (FTO, transmission > 80% in the visible, sheet resistance 15 Ω square<sup>-1</sup>, Japan); Dodecyl-trimethoxysilane (Wuhan University, China); PEG (poly(ethylene glycol),  $M_w = 2 \times 10^4$  g mol<sup>-1</sup>, Aldrich); PEO (poly(ethylene oxide),  $M_w = 2 \times 10^6$  g mol<sup>-1</sup>, Aldrich); P(VDF-HFP) (poly(vinylidene fluoride-cohexafluoropropylene),  $M_w = 4.77 \times 10^5$  g mol<sup>-1</sup>, Elf Atochem);

All the reagents used were of analytical purity and used without further purification.

## 2.2. Fabrication of dye-sensitized TiO<sub>2</sub> photoanode

TiO<sub>2</sub> nanoparticles (P25) were dispersed in 20 ml ethanol and de-ionized water with 0.8 ml acetylacetone. The amounts of 10, 20, 30 and 40% PEG (wt% of the P25 TiO<sub>2</sub> nanoparticles) were added each, respectively, to a separate solution prepared above. Each of the above mixture was ground in an attritor mill for 24 h, then 20 ml ethanol and 0.6 ml triton-X100 were added, and the whole content ground for additional 48 h. The prepared TiO<sub>2</sub> paste was spread on a transparent conducting glass with the conventional “doctor blade” technique. All TiO<sub>2</sub> films were sintered at 450 °C for 30 min. After cooling down to 120 °C, the TiO<sub>2</sub> photoanodes were immersed in the dye N719 ethanol solution and kept at 60 °C overnight to allow the dye to soak into the pores and adsorb on the surface of the TiO<sub>2</sub> nanoparticles. The thickness of each nanoporous TiO<sub>2</sub> photoelectrode obtained was 12 μm, as measured by a profilometer (Form Talysurf Profiler-S4C, Taylor Hobson, UK). The stereoscopic mor-

phologies of the photoelectrodes, prior to dye-sensitization, were scanned by AFM (measured with a SPM-9500J3, Shimadzu, Japan) in tapping mode. The UV–visible spectroscopy of the dye-sensitized TiO<sub>2</sub> photoanodes was measured by a UV–vis–NIR spectrometer (cary 5000, Varian) with a wavelength ranging from 450 nm to 800 nm.

## 2.3. Assembly and characterization of the dye-sensitized solar cells

The polymer electrolytes were prepared according to details given in a previous report [8]. The dye-sensitized nanocrystalline TiO<sub>2</sub> photoelectrodes were heated in oven at 80 °C for several minutes to evaporate water from the pores of the photoelectrodes, making the electrolyte easy to penetrate into the pores of the porous photoanodes. Then the prepared electrolytes were dropped on the surface of the photoanodes and kept in the oven at 80 °C for 2 h to evaporate the redundant organic solvent. Finally, the sputtered Pt counter electrodes were pressed tightly onto the polymer electrolyte with small clips. Baking was continued till counter electrodes stuck to the photoanodes firmly.

Following assembly, several characteristics of the device were evaluated. For current–voltage characteristics measurements, a 1000 W xenon light source (Newport91192, USA) was used to simulate the solar emission (73.5 mW cm<sup>-2</sup>, AM 1.5) and a Keithley 2400 digital source meter unit (USA) was used to measure the current–voltage curves under the light. The light intensity was calibrated by a Si-1787 photodiode (spectral response range: 320–730 nm). The active area of DSSCs was controlled at 0.25 cm<sup>2</sup> by a mask. EIS spectra were recorded over a frequency range of 10<sup>-2</sup> to 10<sup>5</sup> Hz at room temperature. The applied bias voltage was set at open circuit voltage of the DSSCs, and the ac amplitude was 10 mV.

**Table 1**

The roughness calculated from AFM and the properties determined by EIS measurements of different photoelectrodes. RMS is roughness of root mean square;  $r_p$ , resistance at the Pt surface;  $R_k$ , charge-transfer resistance related to recombination of electrons; and  $R_D$ , dc resistance of impedance of diffusion of tri-iodide.

Photoelectrodes	RMS (nm)	$r_p$ ( $\Omega$ )	$R_k$ ( $\Omega$ )	$R_D$ ( $\Omega$ )
10% PEG added	59.8	2.6	34.8	12.1
20% PEG added	82.6	4.0	22.0	10.1
30% PEG added	101.8	3.6	20.9	8.0
40% PEG added	112.5	3.3	19.4	5.6

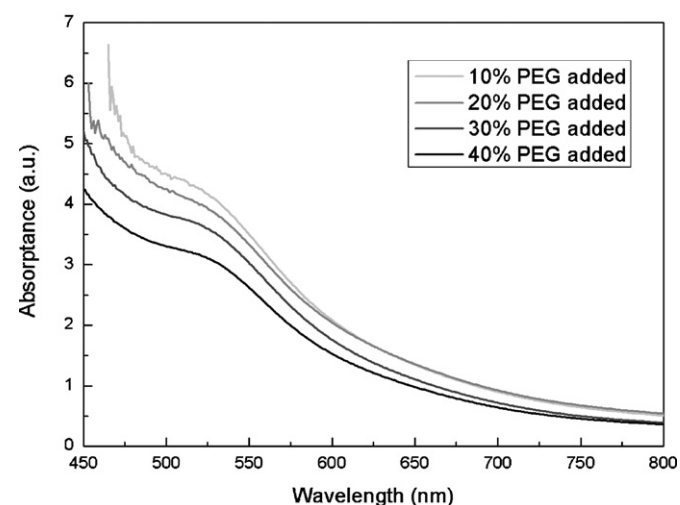
### 3. Results and discussion

#### 3.1. AFM studies of TiO<sub>2</sub> photoelectrodes fabricated with different amounts of PEG added in the paste

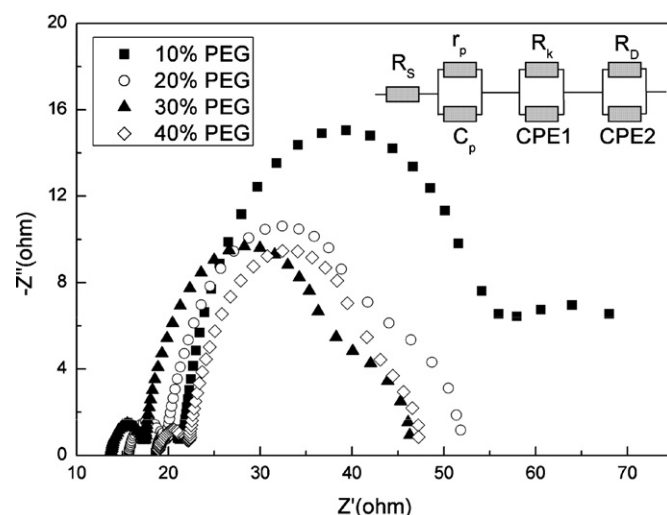
In view of different amounts of PEG added in TiO<sub>2</sub> paste, the fabricated distinct photoelectrodes exhibit various degree of penetration. As a widely used nondestructive method, AFM was used to explore the stereoscopic morphologies and to compare the degree of compact structure of the different photoelectrodes [13]. Probing with high-resolution tapping mode AFM (Fig. 1), it was revealed that the photoelectrode fabricated with little amount of PEG (10%) presents compact porous configuration which makes it rather difficult for quasi-solid electrolyte to penetrate fully into the photoelectrode. In the case of increased amount of PEG (40%) added, the fabricated photoelectrode formed looser porous configuration which is convenient for the penetration of quasi-solid electrolyte. Roughness of root mean square (RMS) calculated from AFM reveals an obvious increase with the increase in PEG. The RMS measurements listed in Table 1 are 59.8, 82.6, 101.8 and 112.5 nm, respectively, for the cases of 10, 20, 30 and 40% of PEG added to TiO<sub>2</sub> pastes. This means that more amount of PEG in the TiO<sub>2</sub> paste leads to more incompact porous photoelectrode which enhances favorable penetration of quasi-solid electrolyte in DSSCs.

#### 3.2. UV–vis study of TiO<sub>2</sub> photoelectrode films with different amounts of PEG loading in the paste

The incompact porous photoelectrode shows the advantage of better penetration of quasi-solid electrolyte, it also decreases the amount of dye sensitized onto the inner surface of the photoelectrode and consequently decreases the number of photon-excited electrons. UV–visible spectroscopy (Fig. 2) provides the absorption



**Fig. 2.** Absorption spectra of N719 dyes adsorbed onto the TiO<sub>2</sub> photoelectrode films fabricated with different amounts of PEG in the paste.

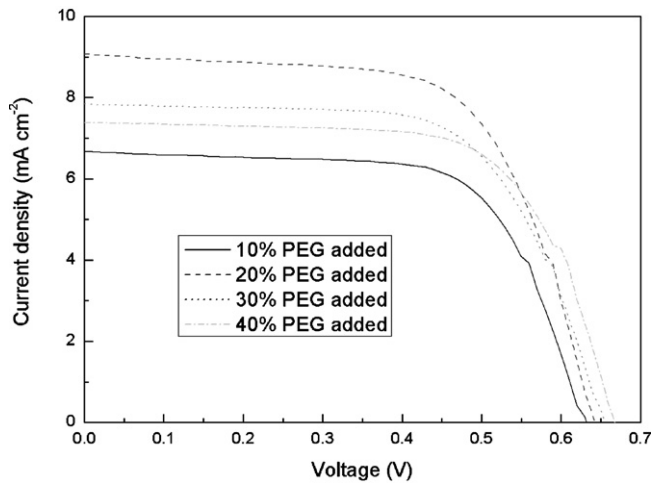


**Fig. 3.** Nyquist plots of the DSSC fabricated with TiO<sub>2</sub> photoelectrode films with different contents of PEG in the paste.

spectra of dyed photoelectrodes which were fabricated with different amounts of PEG. The peak around 535 nm is ascribed to the absorption of dye N-719 [14,15]. In the case of the paste with 10% PEG, the absorption intensity is obviously higher than others since most of the absorption is concentrated in the shortwave region of the visible light for N-719. The absorption intensity decreases as the amount of PEG in the TiO<sub>2</sub> paste increases. This trend shows that looser configuration of photoelectrode fabricated with a large amount of PEG in paste loses the benefit of forming larger inner surface area, an essential property which determines the amount of dye sensitized of the photoelectrodes. This result inevitably hampers photocurrent density in some way.

#### 3.3. EIS analysis of DSSCs fabricated with photoelectrodes of different PEG loadings to paste

Kern et al. and Bisquert, respectively, reported an analysis of EIS which describes electron transport and charge recombination in DSSCs [16–18]. It is well established that the response in the high frequency part is associated with the charge transfer at the counter electrode; while the intermediate frequency part is related to the electron transport in the porous TiO<sub>2</sub> film and recombination at the TiO<sub>2</sub>/electrolyte interface; and the low frequency region is attributed to the diffusion in the electrolyte. From EIS Fig. 3, the diameter of the low frequency arc, which indicates the dc resistance of impedance of diffusion of tri-iodide  $R_D$ , decreased from 12.1  $\Omega$  in the case of 10% PEG to 10.1, 8.0, and 5.6  $\Omega$ , respectively, in the cases of 20, 30 and 40% PEG content, as presented in Table 1. The decrease of dc resistance of impedance of diffusion implies enhanced mobility of tri-iodide in the DSSCs. It also confirms the enhanced penetration of quasi-solid electrolyte as a result of increased PEG loading in the TiO<sub>2</sub> paste. Since the diameter of the high frequency arc, which represents the resistance at the Pt surface  $r_p$ , is about 3  $\Omega$  for all the cases, the different photoelectrodes fabricated relating to different PEG contents in the paste did not show apparent effect on  $r_p$ . The most important part in the whole energy conversion efficiency of DSSCs associates with the intermediate frequency region seen in Fig. 3. The diameter of the central arc relates to electron transport resistance  $R_w$  in TiO<sub>2</sub> and charge-transfer resistance  $R_k$  which occurs due to recombination between the tri-iodide and the electron. Usually, the recombination process is much slower than the process of electron transportation through the TiO<sub>2</sub> layer in DSSCs, so the diameter of the central arc represents the value of  $R_k$  in the case where  $R_k \gg R_w$  [19,20].  $R_k$  decreased



**Fig. 4.** Current density–voltage characteristics of DSSCs fabricated with different photoelectrodes. Measured under AM 1.5,  $73.5 \text{ mW cm}^{-2}$  light intensity, the effective DSSC area was controlled at  $0.25 \text{ cm}^2$  by a mask.

apparently when the amount of PEG added was increased. This obviously results from the recombination between the electrons and tri-iodide. Especially in the cases of 10 and 20% PEG added,  $R_k$  evidently decreased from  $34.8 \Omega$  to  $22.0 \Omega$  (see Table 1), thus indicating the improvement of better penetration of quasi-solid electrolyte into the photoelectrodes of DSSCs without losing most part of dye adsorbed in the  $\text{TiO}_2$  layer. Thereafter, further increase in PEG loading did not effect a significant decrease in  $R_k$  as revealed in the cases of 30 ( $20.9 \Omega$ ) and 40% ( $19.4 \Omega$ ) PEG content. The reason is that the amount of dye adsorbed onto the inner surface of the photoelectrode reduced as the amount of PEG content increased for the same electrode thickness. Decreasing the amount of dye adsorbed results in decreasing the number of photon-excited electrons, thus restricting the upward trend of recombination resulted from better penetration of electrolyte.

#### 3.4. Photocurrent density/voltage characteristics of DSSCs fabricated with $\text{TiO}_2$ photoelectrode films with different amounts of PEG loading

The photocurrent density–voltage curves of DSSCs are shown in Fig. 4. The photoelectric conversion efficiencies ( $\eta$ ) of the device fabricated with different  $\text{TiO}_2$  photoelectrodes and their photovoltaic parameters are presented in Table 2. It is clear that open-circuit photovoltage rose from 630 to 670 mV with the amount of PEG increased from 10 to 40% in the  $\text{TiO}_2$  paste. The open-circuit photovoltage is determined by the difference between the quasi-Fermi level of electrons in  $\text{TiO}_2$  under illumination and the redox potential of the electrolyte [21]. The reduced amount of dye adsorbed onto the inner surface of the photoelectrode and the better penetration of quasi-solid electrolyte have opposing contributions to the photoinjected electron density, so that their effects on the open-circuit photovoltage countervail to some extent. The

**Table 2**

The photovoltaic parameters of DSSC photoelectrodes fabricated with different amounts of PEG added in the paste.  $J_{sc}$ , short-circuit density;  $V_{oc}$ , open-circuit voltage; FF, fill factor;  $\eta$ , photovoltaic conversion efficiency.

DSSCs fabricated with photoelectrodes	$J_{sc}$ ( $\text{mA cm}^{-2}$ )	$V_{oc}$ (mV)	FF	$\eta$ (%)
10% PEG added	6.7	630	0.67	3.8
20% PEG added	9.1	640	0.64	5.1
30% PEG added	7.9	660	0.64	4.5
40% PEG added	7.4	670	0.67	4.5

photoaccumulated charge in the  $\text{TiO}_2$  film can be converted to electron concentration ( $n$ ) by the expression [22]

$$n = \frac{q\phi I_0 \tau}{q(1-P)d} \quad (1)$$

where  $q$  is the charge of an electron,  $\phi$  is the ratio of injected electrons to incident photons,  $I_0$  is the incident photon flux density or incident light intensity,  $\tau$  is time constant,  $P$  is a film porosity and  $d$  is the thickness of  $\text{TiO}_2$  photoelectrode film. Since the photoelectrode film porosity is enlarged with increase of PEG content, increased electron density  $n$  caused a negative potential shift of the quasi-Fermi level under illumination. Otherwise,  $V_{oc}$  depends logarithmically on the inverse concentration of  $\text{I}_3^-$  under illumination [19,23]. The expression for the redox potential with respect to the iodide/iodine concentrations is

$$E = E^0 + \frac{kT}{2q} \ln \frac{[\text{I}_3^-]}{[\text{I}^-]^3} \quad (2)$$

where  $E^0$  is standard potential,  $k$  is the Boltzman constant, and  $T$  is the temperature. Convenient penetration of quasi-solid electrolyte reduced the concentration  $\text{I}_3^-$  accumulated and resulted in positive potential shift of redox potential. So the  $V_{oc}$  increased obviously as we expected. Accompanied with the amount of PEG increase in the  $\text{TiO}_2$  paste are the consequent reduction of dye adsorbed onto the inner surface of the photoelectrode and better penetration of quasi-solid electrolyte, and these two outcomes have contrary effects on the photocurrent. Poor penetration of quasi-solid electrolyte in the DSSCs caused the lowest photocurrent density even when the amount of adsorbed dye was the largest in the case of 10% PEG loading as compared to other PEG loadings in the  $\text{TiO}_2$  paste. For the case of 20% PEG added in the  $\text{TiO}_2$  paste in the range of our experiments, the effect of better penetration of the electrolyte predominated, resulting in the highest photocurrent. At this PEG concentration level, 5.1% energy conversion efficiency was attained. Reduced amount of dye adsorbed onto the inner surface of the photoelectrode gradually caused a decrease in photocurrent and thus retarded the favorable effect of penetration of the electrolyte. At higher amounts of PEG concentration, such as 30% and 40%, the negative effect due to reduced dye outweighs the positive effect generated by increase electrolyte penetration. The energy conversion efficiency consequently decreased to 4.5% for both cases of 30% and 40% PEG loadings, while for the case of 10% PEG, the energy conversion efficiency dropped further to 3.8%.

#### 4. Conclusions

We demonstrated a convenient method of adding PEG in  $\text{TiO}_2$  paste to reduce the amount of dye adsorbed onto the inner surface of the photoelectrode in DSSCs but raise the open-circuit photovoltage and the photocurrent density concurrently. AFM stereoscopic morphology reveals that the photoelectrode of DSSCs fabricated with a higher amount of PEG in the  $\text{TiO}_2$  paste form looser porous configuration, which is convenient for penetration of quasi-solid electrolyte. RMS calculated from AFM shows an obvious increase with increasing quantity of PEG. The amount of dye sensitized onto the inner surface of the photoelectrode decreased directly as the amount of PEG increased in the  $\text{TiO}_2$  paste as confirmed by UV–vis absorption spectra. EIS revealed that charge-transfer resistance evidently decreased which indicates the improvement of better penetration of quasi-solid electrolyte into the photoelectrodes. And the decrease of dc resistance of impedance of diffusion of tri-iodide characterized by EIS indicates enhanced mobility of tri-iodide in the DSSCs. Photovoltaic parameters of the fabricated DSSCs indicate that raised open-circuit photovoltage is caused by enlarged photoelectrode film porosity and the shift of redox level.

Better penetration of quasi-solid electrolyte predominant advantaged effect on the photocurrent for the case of 20% PEG content in TiO<sub>2</sub> paste, giving an energy conversion efficiency of 5.1%. Finally, we conclude that varying the percentage of PEG loading in TiO<sub>2</sub> to fabricate photoelectrodes is beneficial for quasi-solid or solid electrolytes in DSSCs applications. Also, we suggest that employing different molecular weights of PEG might have correspondingly different effects on DSSCs.

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